

INTERNATIONAL STANDARD

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**Universal Serial Bus interfaces for data and power –
Part 3-1: Universal Serial Bus 3.1 Specification**

**Interfaces de bus universel en série pour les données et l'alimentation
électrique –
Partie 3-1: Spécification du bus universel en série 3.1**

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Part 3-1: Universal Serial Bus 3.1 Specification

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The text of this standard is based on the following documents:

CDV	Report on voting
100/2589/CDV	100/2684/RVC

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

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Revision History

Revision	Comments	Issue Date
1.0	Initial release. USB 3.0	November 12, 2008
	Incorporated errata and ECNs	June 6, 2011
1.0	Initial release. USB 3.1	July 26, 2013

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Acknowledgement of Technical Contribution

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Dedicated to the memory of Brad Hosler, the impact of whose accomplishments made the Universal Serial Bus one of the most successful technology innovations of the Personal Computer era.

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